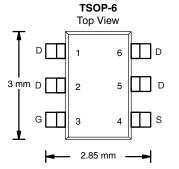


**Vishay Siliconix** 

## P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>d,e</sup>	Q <sub>g</sub> (Typ.)			
	0.0192 at $V_{GS}$ = -10 V	-8				
-30	0.0232 at V <sub>GS</sub> = -6 V	-8	21 nC			
	0.0270 at V <sub>GS</sub> = -4.5 V	-8				



#### **FEATURES**

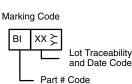
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- Load Switches
- Adaptor Switch
- DC/DC Converter
- For Mobile Computing/Consumer





1

S

0

#### **Ordering Information:**

Si3421DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	-30	v		
Gate-Source Voltage		V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		-8 <sup>e</sup>		
Continuous Drain Current ( $T_1 = 150 \text{ °C}$ )	T <sub>C</sub> = 70 °C		-8 <sup>e</sup>		
Continuous Drain Current $(1_j = 150^{\circ} C)$	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-8.3 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C		-6.7 <sup>a, b</sup>		
Pulsed Drain Current (t = 100 µs)		I <sub>DM</sub>	-50	A	
Continuous Course Durie Diada Current	T <sub>C</sub> = 25 °C	1	-3.5		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-1.7 <sup>a, b</sup>		
Avalanche Current L = 0.1 mH		I <sub>AS</sub>	-15		
Single-Pulse Avalanche Energy	E <sub>AS</sub>	11.25	mJ		
	T <sub>C</sub> = 25 °C		4.2		
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C	ь	2.7	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C	1 -	1.3 <sup>a, b</sup>		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	-55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	40	62.5	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	25	30	0/11	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Maximum under steady state conditions is 110 °C/W.

d. Based on T\_C = 25 °C.

e. Package limited.

Document Number: 62921 For technical questions, contact: pmostechsupport@vishav.com www.vishay.com S13-2289-Rev. A, 04-Nov-13 This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

# Si3421DV

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-		1		1	1	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$				V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			-18		1400	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA		4.6		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1		-3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -30$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			-5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	-30			Α	
		V <sub>GS</sub> = -10 V, I <sub>D</sub> = -7 A		0.0160	0.0192	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -6 V, I <sub>D</sub> = -5 A		0.0193	0.0232		
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3 \text{ A}$			0.0270	1	
Forward Transconductance <sup>a</sup>		V <sub>DS</sub> = -10 V, I <sub>D</sub> = -7 A		30		S	
Dynamic <sup>b</sup>			1	1		1	
Input Capacitance	C <sub>iss</sub>			2580			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		256		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			225			
•		V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -8.3 A		46	69		
Total Gate Charge	Qg			21	32		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -8.3 A		7		nC	
Gate-Drain Charge	Q <sub>gd</sub>			6.1		1	
Gate Resistance	R <sub>g</sub>	f = 1 MHz	1.6	8	16	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_{L}$ = 2.24 $\Omega$		9	18	-	
Turn-Off DelayTime	t <sub>d(off)</sub>	${\sf I}_{\sf D}\cong$ -6.7 A, ${\sf V}_{\sf GEN}$ = -10 V, ${\sf R}_{\sf q}$ = 1 $\Omega$		55	83		
Fall Time	t <sub>f</sub>			13	20		
Turn-On Delay Time	t <sub>d(on)</sub>			58	87	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = -15 V, $R_{L}$ = 2.24 $\Omega$		40	60	1	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ -6.7 A, $V_{GEN}$ = -4.5 V, $R_a$ = 1 $\Omega$		36	54		
Fall Time	t <sub>f</sub>			17	26		
Drain-Source Body Diode Characterist	ics		1	1		1	
Continous Source-Drain Diode Current		T <sub>C</sub> = 25 °C			-3.5		
Pulse Diode Forward Current (t = $100 \mu s$ )	I <sub>SM</sub>				-50	Α	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = -6.7 A, V <sub>GS</sub> = 0 V	1	-0.85	-1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			21.5	33	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = -6.7 A, dl/dt = 100 A/μs,		12	20	nC	
Reverse Recovery Fall Time	ta	$T_{\rm J} = 25 ^{\circ}{\rm C}$		10.5	-		
Reverse Recovery Rise Time	t <sub>b</sub>			11		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

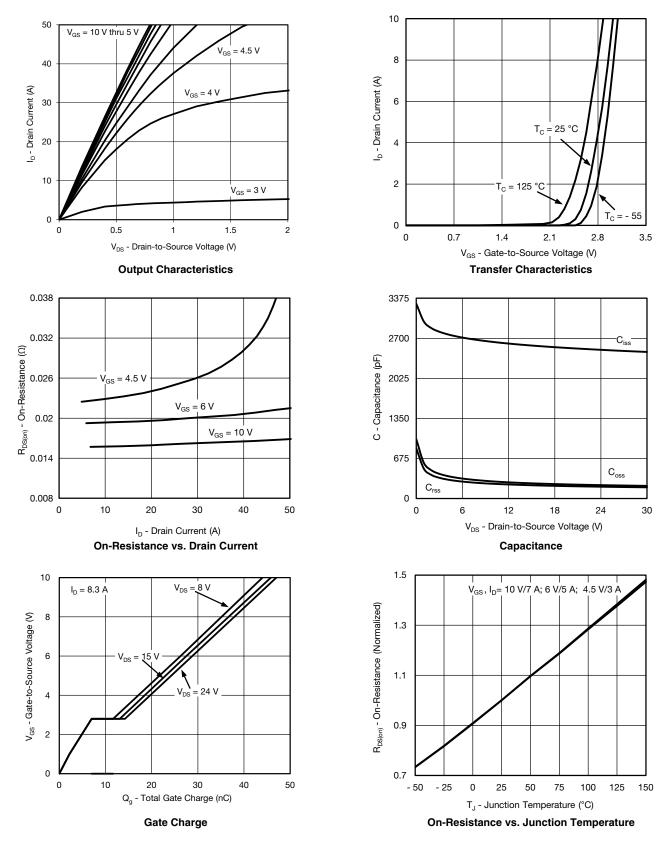
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

www.vishay.com 2 Document Number: 62921 S13-2289-Rev. A, 04-Nov-13



## Si3421DV Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Document Number: 62921 S13-2289-Rev. A, 04-Nov-13 For technical questions, contact: pmostechsupport@vishay.com

www.vishay.com

3

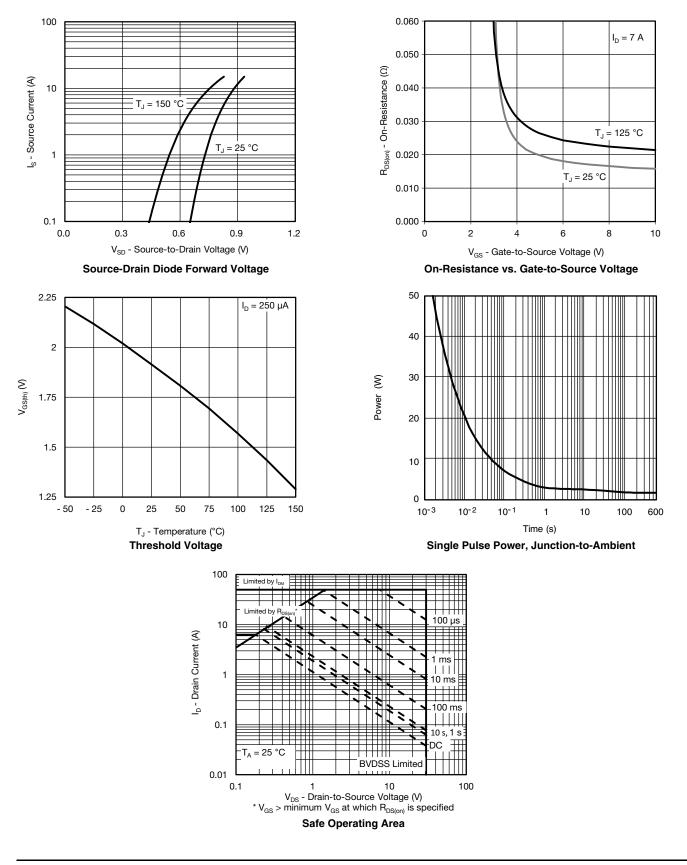
This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

# Si3421DV

## Vishay Siliconix



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



For technical questions, contact: pmostechsupport@vishay.com

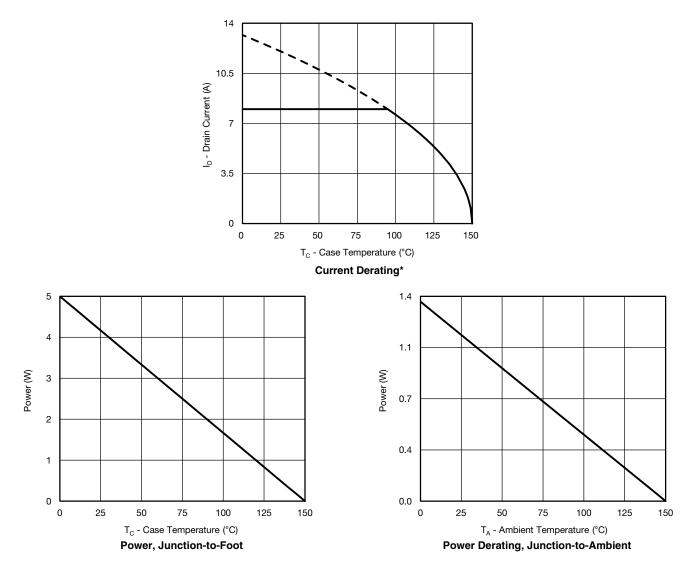
Document Number: 62921 S13-2289-Rev. A, 04-Nov-13

This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



## Si3421DV Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



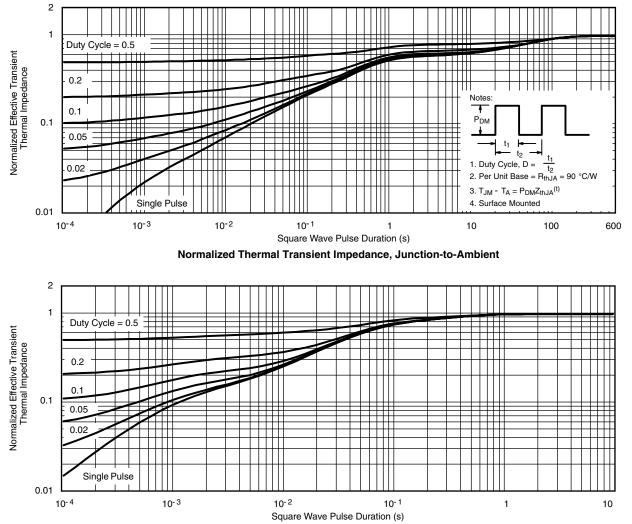
\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

# Si3421DV





### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?62921</u>.

www.vishay.com 6 For technical questions, contact: pmostechsupport@vishay.com

Document Number: 62921 S13-2289-Rev. A, 04-Nov-13

This document is subject to change without notice. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



Package Information

Vishay Siliconix

TSOP: 5/6-LEAD JEDEC Part Number: MO-193C









6-LEAD TSOP



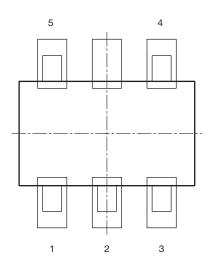
	MIL	LIMETER	RS	INCHES						
Dim	Min	Nom	Max	Min	Nom	Max				
Α	0.91	-	1.10	0.036	-	0.043				
<b>A</b> <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004				
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039				
b	0.30	0.32	0.45	0.012	0.013	0.018				
С	0.10	0.15	0.20	0.004	0.006	0.008				
D	2.95	3.05	3.10	0.116	0.120	0.122				
Е	2.70	2.85	2.98	0.106	0.112	0.117				
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067				
е	0.95 BSC			0.0374 BSC						
<b>e</b> <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079				
L	0.32	-	0.50	0.012	-	0.020				
L <sub>1</sub>	0.60 Ref				0.024 Ref					
L <sub>2</sub>	0.25 BSC				0.010 BSC					
R	0.10	-	-	0.004	-	-				
θ	0°	4°	8°	0°	4°	8°				
$\theta_1$	7° Nom				7° Nom					
		ev. I, 18-Dec	c-06			ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540				

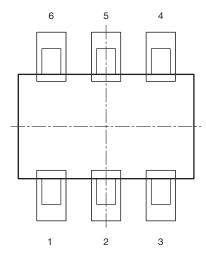
### **PAD** Pattern



Vishay Siliconix

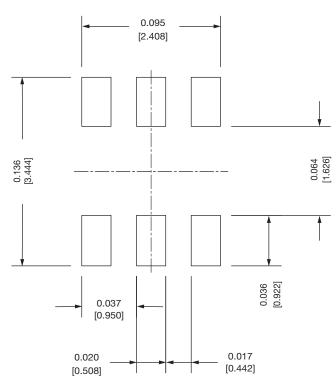
# **Recommended Land Pattern For TSOP-5L / TSOP-6L**





TSOP 5L





#### Note

• All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022	
DWG: 3010	

1



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2025 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED

Revision: 01-Jan-2025

1